## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Sang-Hoon LEE	12/04/2007
Dong-Yun SHIN	12/04/2007

## **RECEIVING PARTY DATA**

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#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11956925

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ATTORNEY DOCKET NUMBER: 4956-0002

NAME OF SUBMITTER: Richard Straussman

**Total Attachments: 3** 

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PATENT

Docket No. 4956-0002

# ASSIGNMENT OF APPLICATION FOR PATENT

WHEREAS:
LEE, Sang-Hoon #105-705, GrantVill Apt., Wolgyeo-3-dong, Nowon-gu, Seoul, 139-956 Republic of Korea
and
SHIN, Dong-Yun #702-911, Cheongsol Apt., Hagyeo-dong, Nowon-gu, Seoul, 139-230 Republic of Korea
(full name(s) and post office address(s) of inventor(s) (including country))
(hereinafter referred to as ASSIGNOR(S)), have made a discovery or invention entitled:
MAGNETIC MEMORY DEVICE USING DOMAIN STRUCTURE AND MULTI-STATE
OF FERROMAGNETIC MATERIAL
(title of discovery or invention)
for which application for Letters Patent of the United States has been executed on even date herewith,
for which application for Letters Patent of the United States has been filed on, under Serial No, and
WHEREAS:
KOREA UNIVERSITY Industrial & Academic Collaboration Foundation  1st floor, Industrial & Academic Collaboration Building, Korea University, Anam-dong,
Seongbuk-gu, Seoul 36-713 Republic of Korea
(name and address of assignee)
(hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire interest in, to and
under said invention and in, to and under Letters Patent or similar legal protection to be obtained
therefore in the United States and in any and all foreign countries.

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PATENT REEL: 020249 FRAME: 0919 NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

Be it known that in consideration of the payment by ASSIGNEE to ASSIGNOR(S) of the sum of ten dollars (\$10.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR(S) hereby sells, assigns and transfers to ASSIGNEE, its successors, legal representatives and assigns, the full and exclusive right, title and interest to said discovery or invention in the United States and its territorial possessions and to all Letters Patent or similar legal protection in the United States and its territorial possessions and to be obtained for said invention by said application or any continuation, division, renewal, substitute or reissue thereof or any legal equivalent thereof in a foreign country for the full term or terms for which the same may be granted.

I, SAID ASSIGNOR(S), hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and any Official of any country or countries foreign to the United States of America whose duty it is to issue Letters Patent on applications as aforesaid, to issue all such Letters Patent for said discovery or invention to the ASSIGNEE, as assignee of the entire right, title and interest in, to and under the same, for the sole use and behoof of the ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

I, SAID, ASSIGNOR(S), hereby covenant that I have full right to convey the entire right, title and interest herein sold, assigned, transferred and set over;

AND I, SAID ASSIGNOR(S) hereby further covenant and agree that the ASSIGNEE its successors, legal representatives, or assigns, may, as allowed by national law, apply for foreign Letters Patent on said discovery or invention and claim the benefits of the International Convention, and that I will, at any time, when called upon to do so by the ASSIGNEE, its successors, legal representatives, or assigns, communicate to the ASSIGNEE, its successors, legal representatives, or assigns, as the case may be, any facts known to me respecting said discovery or invention, and execute and deliver any and all lawful papers that may be necessary or desirable to perfect the title to the said discovery or invention, the said applications and the said Letters Patent in the ASSIGNEE, it's successors, legal representatives and assigns, and that if reissues of the said Letters Patent or disclaimers relating thereto, or divisions, continuations, or refilings of the said applications, or any thereof, shall hereafter be desired by the ASSIGNEE, its successors, legal representatives, or assigns, I will, at any time, when called up to do so by the ASSIGNEE, its successors, legal representatives, or assigns sign all lawful papers, make all rightful oaths, execute and deliver all such disclaimers and all divisional, continuation and reissue applications so desired, and do all lawful acts requisite for the application for such reissues and the procuring thereof and for the filing of such disclaimers and such applications, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention or discover in all

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countries, and without further compensation but at the expense of the ASSIGNEE, its successors, legal representatives and assigns.

Signed:

TEF Sol Hoor

Date: Dec. 4. 2007

(2) Tong Yun

Date: Dec. 4. 2007

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**RECORDED: 12/14/2007**